# 2SK3652

## N-channel enhancement mode MOSFET

#### ■ Features

- Low on-resistance, low Qg
- High avalanche resistance

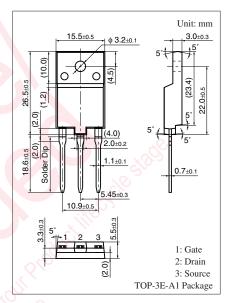
#### Applications

- For PDP
- For high-speed switching

#### ■ Absolute Maximum Ratings $T_C = 25$ °C

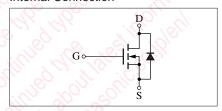
Symbol	Rating	Unit	
V <sub>DSS</sub>	230	V	
V <sub>GSS</sub>	±30	V	
$I_D$	50	A	
$I_{DP}$	200	A	
EAS	2 200	mJ	
P <sub>D</sub>	100	W	
	3		
T <sub>j</sub>	150	°C	
$T_{stg}$	-55 to +150	°C	
	V <sub>DSS</sub> V <sub>GSS</sub> I <sub>D</sub> I <sub>DP</sub> EAS P <sub>D</sub> T <sub>j</sub>	$\begin{array}{c cccc} V_{DSS} & 230 \\ V_{GSS} & \pm 30 \\ I_{D} & 50 \\ I_{DP} & 200 \\ EAS & 2200 \\ P_{D} & 100 \\ \hline & 3 \\ T_{j} & 150 \\ \end{array}$	

Note) \*: L = 1 mH,  $I_L = 50 \text{ A}$ ,  $V_{DD} = 100 \text{ V}$ , 1 pulse,  $T_a = 25^{\circ}\text{C}$ 



Marking Symbol: K3652

#### Internal Connection



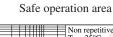
## ■ Electrical Characteristics $T_C = 25$ °C $\pm 3$ °C

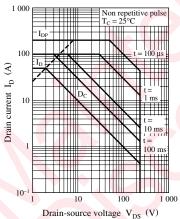
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source surrender voltage	V <sub>DSS</sub>	$I_D = 1 \text{ mA}, V_{GS} = 0$	230			V
Gate threshold voltage	V <sub>th</sub>	$V_{DS} = 25 \text{ V}, I_{D} = 10 \text{ mA}$	2		4	V
Drain-source cutoff current	$I_{DSS}$	$V_{DS} = 184 \text{ V}, V_{GS} = 0$			100	μΑ
Gate-source cutoff current	$I_{GSS}$	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$			±1	μΑ
Drain-source ON resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$		29	40	$m\Omega$
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 25 \text{ V}, I_{D} = 25 \text{ A}$	17	35		S
Short-circuit forward transfer capacitance (Common-source)	C <sub>iss</sub>	$V_{DS} = 25 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		5950		pF
Short-circuit output capacitance (Common-source)	C <sub>oss</sub>			850		pF
Reverse transfer capacitance (Common-source)	C <sub>rss</sub>			80		pF
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 100 \text{ V}, I_D = 25 \text{ A}$		65		ns
Rise time	$T_{\rm r}$	$R_L = 4 \Omega$ , $V_{GS} = 10 V$		140		ns
Turn-off delay time	t <sub>d(off)</sub>			470		ns
Fall time	$t_{\rm f}$			145		ns

## ■ Electrical Characteristics (continued) $T_C = 25$ °C $\pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Diode foward voltage	V <sub>DSF</sub>	$I_{DR} = 50 \text{ A}, V_{GS} = 0$			-1.5	V
Reverse recovery time	t <sub>rr</sub>	$L = 230 \mu H, V_{DD} = 100 V$		235		ns
Reverse recovery charge	Q <sub>rr</sub>	$I_{DR} = 25 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		1180		nC
Gate charge load	Qg	$V_{DD} = 100 \text{ V}, I_D = 25 \text{ A}$		105		nC
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$		40		nC
Gate-drain charge	$Q_{gd}$			14		nC
Thermal resistance (ch-c)	R <sub>th(ch-c)</sub>				1.25	°C/W
Thermal resistance (ch-a)	R <sub>th(ch-a)</sub>				41.6	°C/W

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.





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